

Integrated Current Sensor GXL AN series

Description

GXL AN is a 200A range Integrated Current Sensor (ICS) built with QFN package technology, providing an excellent power density for power PCB current measurements with built in galvanic insulation. This product is a high precision integrated current sensor (ICS) from LEM, where the current goes through its primary pins and does not require a core (coreless product).

The GXL product family provides a very accurate solution for measuring DC and AC currents in all highly compact and demanding industrial and automotive applications. This product uses a very small QFN package technology with large primary pads and wettable flanks for soldering and visual inspection. It provides analog voltage output with best-in-class accuracy together with overcurrent detections (user configurable and factory set).

The current goes through the primary pins (1 to 8) which have a very low internal resistance ($<0.25\text{ m}\Omega$). The secondary pins have 6mm distance creepage / clearance from the primary in order to ensure a good enough isolation level.

These features make the device suitable for high voltage applications requiring high precision and strong immunity against external field with its differential sensing solution.

Main features & Advantages

- Industrial and automotive
- Open loop multi-range current sensor: 200A
- Low electrical resistance $< 0.25\text{m}\Omega$
- Dual supply voltage 5V and 3.3V
- User settable fast overcurrent detection
- Low power consumption
- Compact design for surface mounting on PCB
- High bandwidth
- Galvanic separation between primary and secondary with 6 mm of dCp/dCl
- Reinforced insulation capability

Typical applications

- Drives
- HVAC Inverters
- Appliances
- Solar Inverters
- Automotive

Standards

- IEC 61800-5-1: 2007
- IEC 62109-1: 2010
- IEC 62368-1: 2018 (replacing IEC 60950-1)
- UL 62638-1 (Pending)
- AEC-Q-100 Grade 0 qualified (pending)

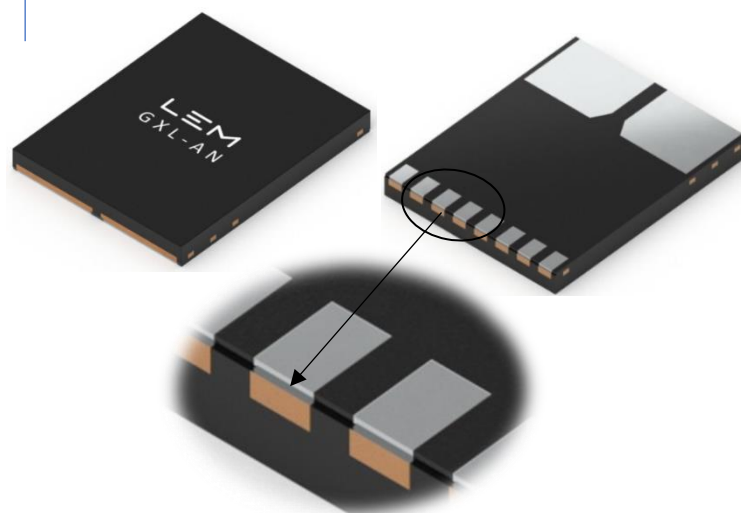
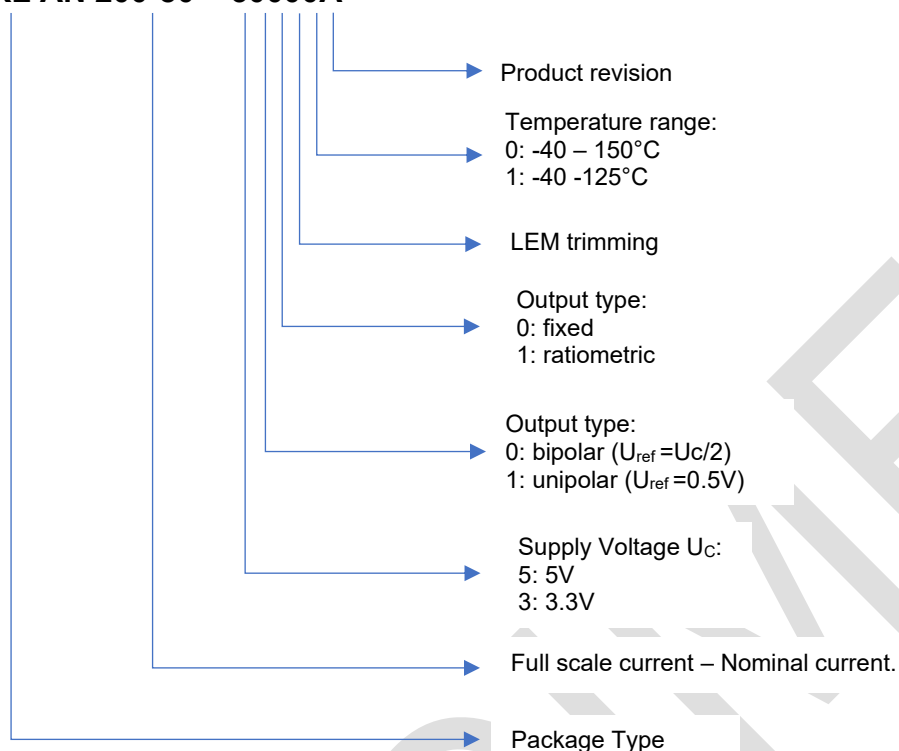


Figure 1: GXL QFN package with wettable flanks



Selection guide

GXL AN 200-80 – 50000A



Standard products

Product name	Full scale range (A peak)	Nominal current (A rms) ¹	Sensitivity (mV/A)	Supply Voltage (V)	Polarity	Output type
GXL AN 125-50 30000B	± 125	± 50	10	3.3 V	Bipolar	Fixed
GXL AN 200-80 30000B	± 200	± 80	6.25	3.3 V	Bipolar	Fixed
GXL AN 125-50 50000B	± 125	± 50	16	5 V	Bipolar	Fixed
GXL AN 200-80 50000B	± 200	± 80	10	5 V	Bipolar	Fixed
GXL AN 125-50 30100B	± 125	± 50	10	3.3 V	Bipolar	Ratiometric
GXL AN 200-80 30100B	± 200	± 80	6.25	3.3 V	Bipolar	Ratiometric
GXL AN 125-50 50100B	± 125	± 50	16	5 V	Bipolar	Ratiometric
GXL AN 200-80 50100B	± 200	± 80	10	5 V	Bipolar	Ratiometric

Table 1: GXL AN Products

¹ Trimmings at LEM are done at the half of nominal current ($I_{PN}/2$)

Pinout

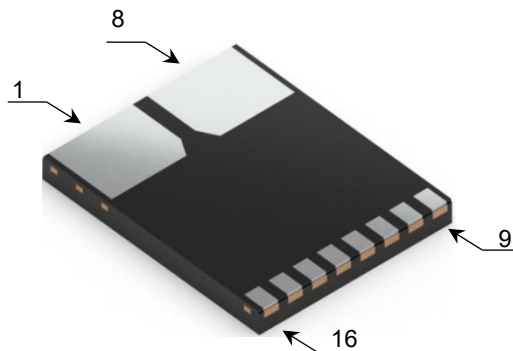


Figure 2: GXL package with pin number (bottom view)

Pin#	Name	Type	Description
1	I_{P+}	Input	Input (+) of the primary current
8	I_{P-}	Input	Input (-) of the primary current
9	U_C	Power	Supply voltage
10	$U_{E\,OCD}$	Input	External OCD threshold voltage terminal
11	OCD_{INT}	Output	Internal OCD
12	U_{out}	Output	Output voltage
13	U_{ref}	Output	Reference voltage (for non-ratiometric products)
14	NC	N/A	Connect to GND
15	OCD_{EXT}	Output	External OCD terminal
16	GND	Ground	Ground terminal

Table 2: GXL AN Device Pin Function Description

Application circuits

Typical schematics GXL AN (ratiometric operating mode)

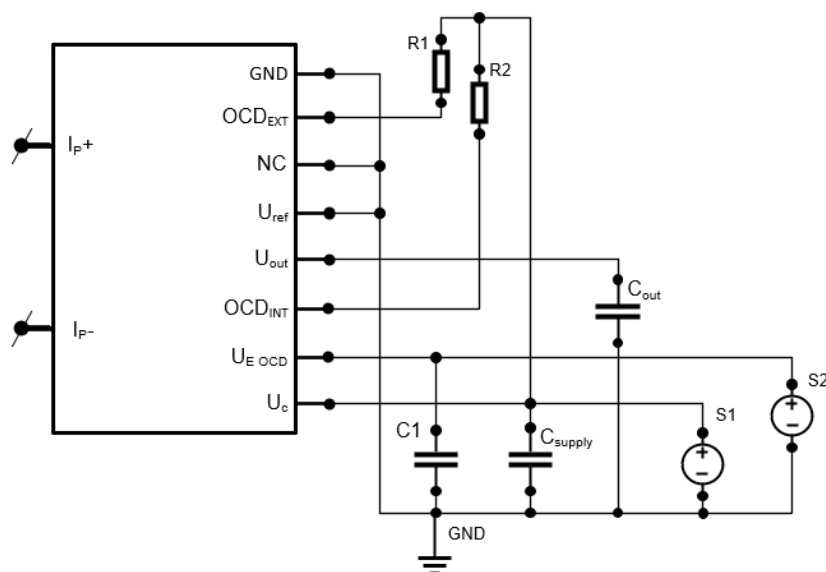


Figure 3: Typical application schematics; GXL AN ratiometric products

Reference	Value	Min	Max	Unit	Comment
C_{supply}	47	10	-	nF	Decoupling capacitor. To be placed as close as possible to U _C pin of the sensor
C_{out}	4.7	-	6	nF	Output capacitor. Ensure stable output operation on full bandwidth. To be placed as close as possible to U _{out} pin of the sensor.
C1	4.7			nF	Only mounted if OCD_EXT functionality is used. This capacitor ensures a better immunity of U _{E_OCD} to noise and transients. OCD_EXT accuracy cannot be guaranteed if not mounted. To be placed as close as possible to U _{E_OCD} pin of the sensor
R1	10	1	50	kΩ	OCD Pull up. It must be connected to U _C , as close as possible to OCD_EXT pin of the sensor.
R2	10	1	50	kΩ	OCD Pull up. It must be connected to U _C , as close as possible to OCD_INT pin of the sensor.
S1	5V / 3.3V			V	Supply voltage matching product requirements
S2	Refer to "External OCD" chapter			V	OCD threshold voltage source must be very stable to ensure an accurate threshold. Different methods can be used to fix the OCD threshold: - External source (DAC, amplifier, Zener diode...) - Resistor divider, connected to U _C or U _{ref}

Table 3: Typical recommended components GXL AN ratiometric products

Typical schematics GXL AN (fixed operating mode)

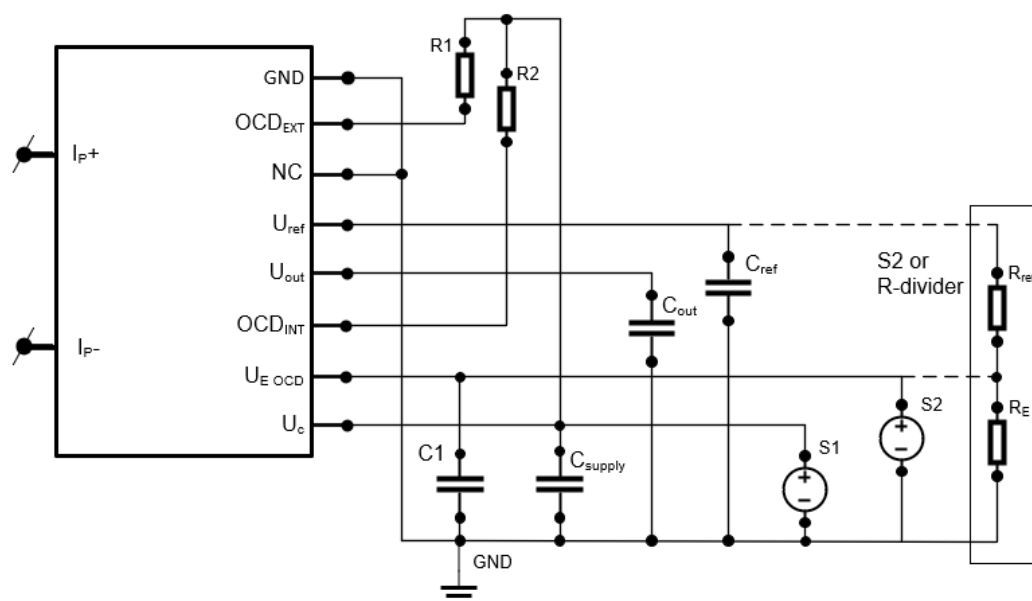


Figure 4: Typical application schematics; GXL AN fixed products

Reference	Value	Min	Max	Unit	Comment
Csupply	47	10	-	nF	Decoupling capacitor. To be placed as close as possible to U _C pin of the sensor
Cout	4.7	-	6	nF	Output capacitor. Ensure stable output operation on full bandwidth. To be placed as close as possible to U _{out} pin of the sensor.
C1	4.7			nF	Only mounted if OCD_EXT functionality is used. This capacitor ensures a better immunity of U _{E_OCD} to noise and transients. OCD_EXT accuracy cannot be guaranteed if not mounted. To be placed as close as possible to U _{E_OCD} pin of the sensor
Cref	4.7	-	6	nF	Output capacitor on reference pin. Insure stable output operation on full bandwidth. To be placed as close as possible to U _{ref} pin of the sensor.
R1	10	1	50	kΩ	OCD Pull up. It must be connected to U _C , as close as possible to OCD_EXT pin of the sensor.
R2	10	1	50	kΩ	OCD Pull up. It must be connected to U _C , as close as possible to OCD_INT pin of the sensor.
Rref	47	4.7	-	kΩ	Refer to “External OCD” chapter
RE	47	4.7	-	kΩ	
S1	5V / 3.3V			V	Supply voltage matching product requirements
S2	Refer to “External OCD” chapter			V	OCD threshold voltage source must be very stable to ensure an accurate threshold. Different methods can be used to fix the OCD threshold: - External source (DAC, amplifier, Zener diode...) - Resistor divider, connected to U _C or U _{ref}

Table 4: Typical recommended components GXL AN fixed products

For more details, please read “ICS Products Schematics” application note available on LEM website.

Block diagram

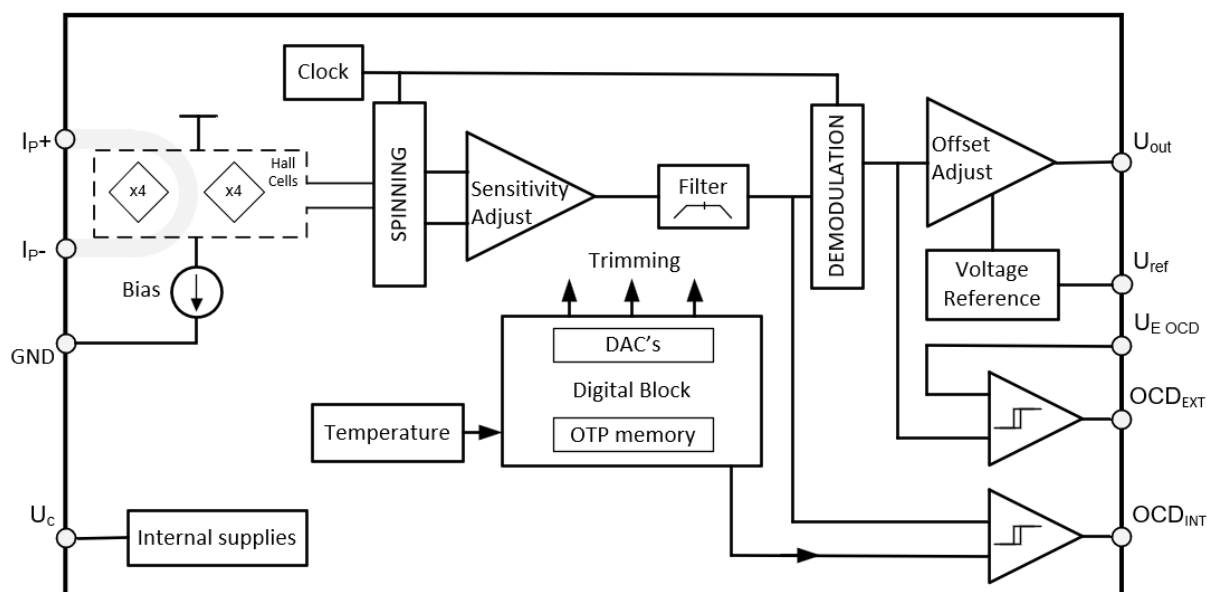


Figure 5: Block diagram GXL AN

Absolute maximum ratings

Parameter	Symbol	Unit	Value
Maximum supply voltage	$U_{C\ max}$	V	7.5
Maximum voltage on other pins	U_{max}	V	7.5
Electrostatic discharge voltage (HBM - Human Body Model)	$U_{ESD\ HBM}$	kV	2
Electrostatic discharge voltage (CDM - Charged Device Model)	$U_{ESD\ CDM}$	V	500
Maximum junction temperature	$T_{J\ max}$	°C	165

Table 5

Absolute maximum ratings apply at 25 °C unless otherwise noted.

Stresses above these ratings may cause permanent damage.

Exposure to absolute maximum ratings for extended periods may degrade reliability.

Environmental and mechanical characteristics

Parameter	Symbol	Unit	Min	Typ	Max	Comment
Ambient operating temperature	T_A	°C	-40		150	
Ambient storage temperature	$T_{A\ st}$	°C	-55		165	
Thermal resistance junction to case	$R_{th\ JC}$	K/W		18		TBC
Thermal resistance junction to ambient	$R_{th\ JA}$	K/W		9		
Mass	m	g		1.4		TBC

Table 6

Insulation characteristics GXL

Parameter	Symbol	Unit	Value	Comment
RMS voltage for AC insulation test, 50Hz, 1min	U_d	kV	4.53 ²	According to IEC 62368-1
Impulse withstand voltage 1.2/50 μ s	U_{NI}	kV	6.40	According to IEC 62109-1, IEC 61800-5-1
RMS recurring peak voltage (Partial discharge test)	U_{PD}	V	933	According to IEC 62109-1, IEC 61800-5-1
RMS inception voltage (Partial discharge test)	$U_{t\ inception}$	V	1238	According to IEC 62109-1, IEC 61800-5-1
RMS extinction voltage (Partial discharge test)	$U_{t\ extinction}$	V	990	According to IEC 62109-1, IEC 61800-5-1
Clearance (pri. -sec.)	d_{Cl}	mm	6	Shortest distance through air
Creepage distance (pri. -sec.)	d_{Cp}	mm	6	Shortest path along device body
Case material			V0	According to UL94, flammability
Comparative tracking index	CTI		600	Grade requirements mass compound

Table 7

Working voltage according to IEC 62368-1

Working voltage		PD 2	Standards
Basic insulation	RMS voltage (V)	1192	IEC 62368-1 (replacing IEC 60950-1)
Reinforced insulation	RMS voltage (V)	593	

Table 8

Rated insulation voltage according to IEC 61800-5-1

Rated insulation voltage		OV II / PD 2	OV III/ PD 2	Standards
Basic isolation	RMS voltage (V)	1104	600	IEC 61800-5-1
Reinforced isolation	RMS voltage (V)	593	300	

Table 9

Rated insulation voltage according to IEC 62109-1

Rated insulation voltage		OV II / PD 2	OV III/ PD 2	Standards
Basic isolation	RMS voltage (V)	> 1000	600	IEC 62109-1
Reinforced isolation	RMS voltage (V)	593	300	

Table 10

² 100% tested in production at 4.07 kV level.

Common electrical data (independent of sensitivity)

At $T_A = 25^\circ\text{C}$, $U_C = +5\text{ V}$, $R_L = 100\text{ k}\Omega$, unless otherwise noted

Supply characteristics and consumption

Parameter	Symbol	Unit	Min	Typ	Max	Comment
DC supply voltage	U_C	V	4.5	5	5.5	5V versions
DC supply voltage	U_C	V	3.135	3.3	3.465	3V3 versions
DC Current consumption	I_C	mA		20	26	
Start-up time	T_{start}	ms		3		

Table 11

Primary characteristics

Parameter	Symbol	Unit	Min	Typ	Max	Comment
Resistance of the primary	R_P	m Ω		<0.25		$T_A = 25^\circ\text{C}$
Primary resistance drift	TcR_P	$\mu\Omega/^\circ\text{C}$		0.95		

Table 12

Output characteristics

Parameter	Symbol	Unit	Min	Typ	Max	Comment
Output voltage range	$U_{out}-U_{ref}$	V	-2		2	5V versions $U_C \geq 4.6\text{ V}$, @ I_{PM}
Output voltage range	$U_{out}-U_{ref}$	V	-1.25		1.25	3V3 versions @ I_{PM}
Output internal resistance of Uout	R_{out}	Ω		1		
Maximum output current source of Uout	I_{Omax}	mA	20			
Maximum input current sink of Uout	I_{Imax}	mA	20			
Load capacitance on Uout	C_L	nF	0	4.7	6	
Delay time (slope of $I_{PN} = 20\text{A}/\mu\text{s}$)	t_{D10}	μs		1.3		@ 10 % of I_{PN}
	t_{D90}	μs		1.6		@ 90 % of I_{PN}
Frequency bandwidth	BW	kHz		300		@ -3dB

Table 13

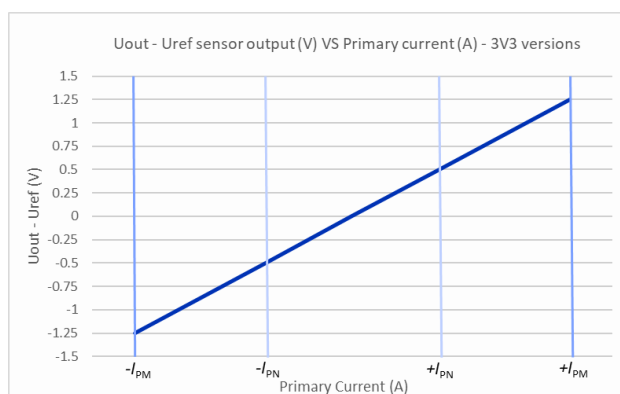
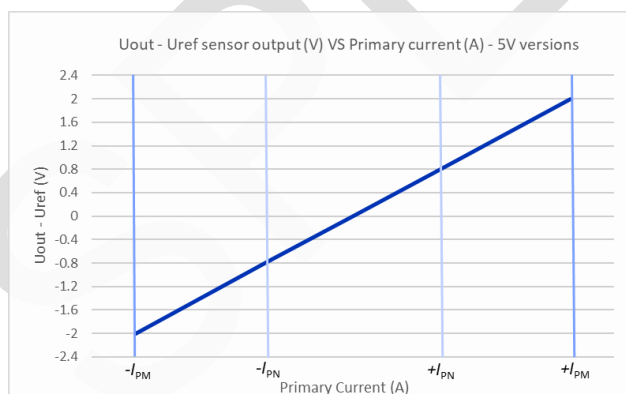


Figure 6 & 7: Sensor output voltage referred to Uref.

Internal reference characteristics

Parameter	Symbol	Unit	Min	Typ	Max	Comment
Internal reference voltage @ $I_P = 0$ A	U_{Iref}	V	2.48	2.5	2.52	5V versions
Internal reference voltage @ $I_P = 0$ A	$U_{out}-U_{ref}$	V	1.64	1.65	1.66	3V3 versions
Temperature coefficient of U_{ref}	TCU_{ref}	ppm/K	-220	± 75	220	$T_A = -40^{\circ}\text{C} \div 150^{\circ}\text{C}$
Output internal resistance of U_{ref}	R_{ref}	Ω		5		
Maximum output current source of U_{ref}	I_{Omax}	mA		0.5	1	
Maximum input current sink of U_{ref}	I_{Imax}	mA		0.5	1	

Table 14

Lifetime parameters

Parameter	Symbol	Unit	Min	Typ	Max	Comment
Sensitivity error drift after ageing	ϵ_s	%		TBD		TBC based on characterization after qualification.
Offset drift after ageing	U_{OE}	mV		TBD		TBC based on characterization after qualification.
Total accuracy over temp	ϵ_{tot}	%		TBD		TBC based on characterization after qualification.
Total accuracy over lifetime	ϵ_{tot}	%		TBD		TBC based on characterization after qualification.

Table 15

Electrical data GXL AN 125-50 30000B

At $T_A = 25^\circ\text{C}$, $U_C = +3.3\text{ V}$, $R_L = 100\text{ k}\Omega$, unless otherwise noted

Parameter	Symbol	Unit	Min	Typ	Max	Comment
Primary nominal current	I_{PN}	A		50		
Primary current, measuring range	I_{PM}	A	-125		125	
Nominal sensitivity	S_N	mV/A		10		500 mV @ I_{PN}
Sensitivity error @35°C	ε_S	%	-0.5		0.5	$T_A = 35^\circ\text{C}$
Sensitivity error @35°C-150°C	ε_{SHOT}	%	-2.1		2.1	$T_A = 35^\circ\text{C} \div 150^\circ\text{C}$
Sensitivity error @-40°C-35°C	ε_{SCOLD}	%	-2.3		2.3	$T_A = -40^\circ\text{C} \div 35^\circ\text{C}$
Sum of sensitivity and linearity error	ε_{SL25}	% of I_{PM}	-0.7		0.7	$T_A = 35^\circ\text{C}$
Electrical offset voltage	U_{OE}	mV	-5		5	$U_{out}-U_{Iref}$ @ $U_{Iref}=1.65\text{V}$
Electrical offset error @35°C-150°C	U_{OEHOT}	mV	-7		7	$U_{out}-U_{ref}$
Electrical offset error @-40°C-35°C	U_{OECOLD}	mV	-6.5		6.5	$U_{out}-U_{ref}$
Noise voltage spectral density	U_{n0}	$\mu\text{V}/\text{Hz}^{1/2}$		5.1		$U_{out}-U_{ref}$
Linearity error 0 ... $\pm I_{PN}$	ε_L	%	-0.5		0.5	Referred to I_{PN}
Linearity error 0 ... $\pm I_{PM}$	ε_L	%	-0.5		0.5	Referred to I_{PM} - TBC
Total error at I_{PN}	ε_{tot}	% of I_{PN}	-1		1	$T_A = -40^\circ\text{C} \div 150^\circ\text{C}$

Table 16

Electrical data GXL AN 200-80 30000B

At $T_A = 25^\circ\text{C}$, $U_C = +3.3\text{ V}$, $R_L = 100\text{ k}\Omega$, unless otherwise noted

Parameter	Symbol	Unit	Min	Typ	Max	Comment
Primary nominal current	I_{PN}	A		80		
Primary current, measuring range	I_{PM}	A	-200		200	
Nominal sensitivity	S_N	mV/A		6.25		500 mV @ I_{PN}
Sensitivity error @35°C	ε_S	%	-0.5		0.5	$T_A = 35^\circ\text{C}$
Sensitivity error @35°C-150°C	ε_{SHOT}	%	-2.1		2.1	$T_A = 35^\circ\text{C} \div 150^\circ\text{C}$
Sensitivity error @-40°C-35°C	ε_{SCOLD}	%	-2.3		2.3	$T_A = -40^\circ\text{C} \div 35^\circ\text{C}$
Sum of sensitivity and linearity error	ε_{SL25}	% of I_{PM}	-0.7		0.7	$T_A = 35^\circ\text{C}$
Electrical offset voltage	U_{OE}	mV	-5		5	$U_{out}-U_{Iref}$ @ $U_{Iref}=1.65\text{V}$
Electrical offset error @35°C-150°C	U_{OEHOT}	mV	-7		7	$U_{out}-U_{ref}$
Electrical offset error @-40°C-35°C	U_{OECOLD}	mV	-6.5		6.5	$U_{out}-U_{ref}$
Noise voltage spectral density	U_{n0}	$\mu\text{V}/\text{Hz}^{1/2}$		3.7		$U_{out}-U_{ref}$
Linearity error 0 ... $\pm I_{PN}$	ε_L	%	-0.5		0.5	Referred to I_{PN}
Linearity error 0 ... $\pm I_{PM}$	ε_L	%	-0.5		0.5	Referred to I_{PM} - TBC
Total error at I_{PN}	ε_{tot}	% of I_{PN}	-1		1	$T_A = -40^\circ\text{C} \div 150^\circ\text{C}$

Table 17

Electrical data GXL AN 125-50 50000B

At $T_A = 25^\circ\text{C}$, $U_C = +5\text{ V}$, $R_L = 100\text{ k}\Omega$, unless otherwise noted

Parameter	Symbol	Unit	Min	Typ	Max	Comment
Primary nominal current	I_{PN}	A		50		
Primary current, measuring range	I_{PM}	A	-125		125	
Nominal sensitivity	S_N	mV/A		16		800 mV @ I_{PN}
Sensitivity error @35°C	ε_S	%	-0.5		0.5	$T_A = 35^\circ\text{C}$
Sensitivity error @35°C-150°C	ε_{SHOT}	%	-2.1		2.1	$T_A = 35^\circ\text{C} \div 150^\circ\text{C}$
Sensitivity error @-40°C-35°C	ε_{SCOLD}	%	-2.3		2.3	$T_A = -40^\circ\text{C} \div 35^\circ\text{C}$
Sum of sensitivity and linearity error	ε_{SL25}	% of I_{PM}	-0.7		0.7	$T_A = 35^\circ\text{C}$
Electrical offset voltage	U_{OE}	mV	-5		5	$U_{out}-U_{Iref}$ @ $U_{Iref}=2.5\text{ V}$
Electrical offset error @35°C-150°C	U_{OEHOT}	mV	-7		7	$U_{out}-U_{ref}$
Electrical offset error @-40°C-35°C	U_{OECOLD}	mV	-6.5		6.5	$U_{out}-U_{ref}$
Noise voltage spectral density	U_{n0}	$\mu\text{V}/\text{Hz}^{1/2}$		5.7		$U_{out}-U_{ref}$
Linearity error 0 ... $\pm I_{PN}$	ε_L	%	-0.5		0.5	Referred to I_{PN}
Linearity error 0 ... $\pm I_{PM}$	ε_L	%	-0.5		0.5	Referred to I_{PM} - TBC
Total error at I_{PN}	ε_{tot}	% of I_{PN}	-1		1	$T_A = -40^\circ\text{C} \div 150^\circ\text{C}$

Table 18

Electrical data GXL AN 200-80 50000B

At $T_A = 25^\circ\text{C}$, $U_C = +5\text{ V}$, $R_L = 100\text{ k}\Omega$, unless otherwise noted

Parameter	Symbol	Unit	Min	Typ	Max	Comment
Primary nominal current	I_{PN}	A		80		
Primary current, measuring range	I_{PM}	A	-200		200	
Nominal sensitivity	S_N	mV/A		10		800 mV @ I_{PN}
Sensitivity error @35°C	ε_S	%	-0.5		0.5	$T_A = 35^\circ\text{C}$
Sensitivity error @35°C-150°C	ε_{SHOT}	%	-2.1		2.1	$T_A = 35^\circ\text{C} \div 150^\circ\text{C}$
Sensitivity error @-40°C-35°C	ε_{SCOLD}	%	-2.3		2.3	$T_A = -40^\circ\text{C} \div 35^\circ\text{C}$
Sum of sensitivity and linearity error	ε_{SL25}	% of I_{PM}	-0.7		0.7	$T_A = 35^\circ\text{C}$
Electrical offset voltage	U_{OE}	mV	-5		5	$U_{out}-U_{Iref}$ @ $U_{Iref}=2.5\text{ V}$
Electrical offset error @35°C-150°C	U_{OEHOT}	mV	-7		7	$U_{out}-U_{ref}$
Electrical offset error @-40°C-35°C	U_{OECOLD}	mV	-6.5		6.5	$U_{out}-U_{ref}$
Noise voltage spectral density	U_{n0}	$\mu\text{V}/\text{Hz}^{1/2}$		3.6		$U_{out}-U_{ref}$
Linearity error 0 ... $\pm I_{PN}$	ε_L	%	-0.5		0.5	Referred to I_{PN}
Linearity error 0 ... $\pm I_{PM}$	ε_L	%	-0.5		0.5	Referred to I_{PM} - TBC
Total error at I_{PN}	ε_{tot}	% of I_{PN}	-1		1	$T_A = -40^\circ\text{C} \div 150^\circ\text{C}$

Table 19

Electrical data GXL AN 125-50 30100B

At $T_A = 25\text{ °C}$, $U_C = +3.3\text{ V}$, $R_L = 100\text{ k}\Omega$, unless otherwise noted

Parameter	Symbol	Unit	Min	Typ	Max	Comment
Primary nominal current	I_{PN}	A		50		
Primary current, measuring range	I_{PM}	A	-125		125	
Nominal sensitivity	S_N	mV/A		10		500 mV @ I_{PN}
Sensitivity error @35°C	ϵ_S	%	-0.5		0.5	$T_A = 35\text{ °C}$
Sensitivity error @35°C-150°C	ϵ_{SHOT}	%	-2.1		2.1	$T_A = 35\text{ °C} \div 150\text{ °C}$
Sensitivity error @-40°C-35°C	ϵ_{SCOLD}	%	-2.3		2.3	$T_A = -40\text{ °C} \div 35\text{ °C}$
Sum of sensitivity and linearity error	ϵ_{SL25}	% of I_{PM}	-0.7		0.7	$T_A = 35\text{ °C}$
Electrical offset voltage	U_{OE}	mV	-5		5	$U_{out}-U_{Iref}$ @ $U_{Iref}=1.65\text{ V}$
Electrical offset error @35°C-150°C	U_{OEHOT}	mV	-7		7	$U_{out}-U_{ref}$
Electrical offset error @-40°C-35°C	U_{OECOLD}	mV	-6.5		6.5	$U_{out}-U_{ref}$
Noise voltage spectral density	U_{n0}	$\mu\text{V}/\text{Hz}^{1/2}$		5.5		$U_{out}-GND$
Linearity error 0 ... $\pm I_{PN}$	ϵ_L	%	-0.5		0.5	Referred to I_{PN}
Linearity error 0 ... $\pm I_{PM}$	ϵ_L	%	-0.5		0.5	Referred to I_{PM} - TBC
Total error at I_{PN}	ϵ_{tot}	% of I_{PN}	-1		1	$T_A = -40\text{ °C} \div 150\text{ °C}$
Ratiometricity Error (sensitivity)	ϵ_R	%		± 0.5		$T_A = -40\text{ °C} \div 150\text{ °C}$ - TBC $U_C = 3.15 \div 3.45\text{ V}$
Ratiometricity Error (offset)	ϵ_{RO}	mV	-10		10	$T_A = -40\text{ °C} \div 150\text{ °C}$

Table 20

Electrical data GXL AN 200-80 30100B

At $T_A = 25\text{ °C}$, $U_C = +3.3\text{ V}$, $R_L = 100\text{ k}\Omega$, unless otherwise noted

Parameter	Symbol	Unit	Min	Typ	Max	Comment
Primary nominal current	I_{PN}	A		80		
Primary current, measuring range	I_{PM}	A	-200		200	
Nominal sensitivity	S_N	mV/A		6.25		500 mV @ I_{PN}
Sensitivity error @35°C	ϵ_S	%	-0.5		0.5	$T_A = 35\text{ °C}$
Sensitivity error @35°C-150°C	ϵ_{SHOT}	%	-2.1		2.1	$T_A = 35\text{ °C} \div 150\text{ °C}$
Sensitivity error @-40°C-35°C	ϵ_{SCOLD}	%	-2.3		2.3	$T_A = -40\text{ °C} \div 35\text{ °C}$
Sum of sensitivity and linearity error	ϵ_{SL25}	% of I_{PM}	-0.7		0.7	$T_A = 35\text{ °C}$
Electrical offset voltage	U_{OE}	mV	-5		5	$U_{out}-U_{Iref}$ @ $U_{Iref}=1.65\text{ V}$
Electrical offset error @35°C-150°C	U_{OEHOT}	mV	-7		7	$U_{out}-U_{ref}$
Electrical offset error @-40°C-35°C	U_{OECOLD}	mV	-6.5		6.5	$U_{out}-U_{ref}$
Noise voltage spectral density	U_{n0}	$\mu\text{V}/\text{Hz}^{1/2}$		3.7		$U_{out}-GND$
Linearity error 0 ... $\pm I_{PN}$	ϵ_L	%	-0.5		0.5	Referred to I_{PN}
Linearity error 0 ... $\pm I_{PM}$	ϵ_L	%	-0.5		0.5	Referred to I_{PM} - TBC
Total error at I_{PN}	ϵ_{tot}	% of I_{PN}	-1		1	$T_A = -40\text{ °C} \div 150\text{ °C}$
Ratiometricity Error (sensitivity)	ϵ_R	%		± 0.5		$T_A = -40\text{ °C} \div 150\text{ °C}$ - TBC $U_C = 3.15 \div 3.45\text{ V}$
Ratiometricity Error (offset)	ϵ_{RO}	mV	-10		10	$T_A = -40\text{ °C} \div 150\text{ °C}$

Table 21

Electrical data GXL AN 125-50 50100B

At $T_A = 25^\circ\text{C}$, $U_C = +5\text{ V}$, $R_L = 100\text{ k}\Omega$, unless otherwise noted

Parameter	Symbol	Unit	Min	Typ	Max	Comment
Primary nominal current	I_{PN}	A		50		
Primary current, measuring range	I_{PM}	A	-125		125	
Nominal sensitivity	S_N	mV/A		16		800 mV @ I_{PN}
Sensitivity error @35°C	ϵ_S	%	-0.5		0.5	$T_A = 35^\circ\text{C}$
Sensitivity error @35°C-150°C	ϵ_{SHOT}	%	-2.1		2.1	$T_A = 35^\circ\text{C} \div 150^\circ\text{C}$
Sensitivity error @-40°C-35°C	ϵ_{SCOLD}	%	-2.3		2.3	$T_A = -40^\circ\text{C} \div 35^\circ\text{C}$
Sum of sensitivity and linearity error	ϵ_{SL25}	% of I_{PM}	-0.7		0.7	$T_A = 35^\circ\text{C}$
Electrical offset voltage	U_{OE}	mV	-5		5	$U_{out}-U_{Iref}$ @ $U_{Iref}=2.5\text{V}$
Electrical offset error @35°C-150°C	U_{OEHOT}	mV	-7		7	$U_{out}-U_{ref}$
Electrical offset error @-40°C-35°C	U_{OECOLD}	mV	-6.5		6.5	$U_{out}-U_{ref}$
Noise voltage spectral density	U_{n0}	$\mu\text{V}/\text{Hz}^{1/2}$		5.7		$U_{out}-GND$
Linearity error 0 ... $\pm I_{PN}$	ϵ_L	%	-0.5		0.5	Referred to I_{PN}
Linearity error 0 ... $\pm I_{PM}$	ϵ_L	%	-0.5		0.5	Referred to I_{PM} - TBC
Total error at I_{PN}	ϵ_{tot}	% of I_{PN}	-1		1	$T_A = -40^\circ\text{C} \div 150^\circ\text{C}$
Ratiometricity Error (sensitivity)	ϵ_R	%		± 0.5		$T_A = -40^\circ\text{C} \div 150^\circ\text{C}$ - TBC $U_C = 4.5 \div 5.5\text{V}$
Ratiometricity Error (offset)	ϵ_{RO}	mV	-10		10	$T_A = -40^\circ\text{C} \div 150^\circ\text{C}$

Table 22

Electrical data GXL AN 200-80 50100B

At $T_A = 25^\circ\text{C}$, $U_C = +5\text{ V}$, $R_L = 100\text{ k}\Omega$, unless otherwise noted

Parameter	Symbol	Unit	Min	Typ	Max	Comment
Primary nominal current	I_{PN}	A		80		
Primary current, measuring range	I_{PM}	A	-200		200	
Nominal sensitivity	S_N	mV/A		10		800 mV @ I_{PN}
Sensitivity error @35°C	ϵ_S	%	-0.5		0.5	$T_A = 35^\circ\text{C}$
Sensitivity error @35°C-150°C	ϵ_{SHOT}	%	-2.1		2.1	$T_A = 35^\circ\text{C} \div 150^\circ\text{C}$
Sensitivity error @-40°C-35°C	ϵ_{SCOLD}	%	-2.3		2.3	$T_A = -40^\circ\text{C} \div 35^\circ\text{C}$
Sum of sensitivity and linearity error	ϵ_{SL25}	% of I_{PM}	-0.7		0.7	$T_A = 35^\circ\text{C}$
Electrical offset voltage	U_{OE}	mV	-5		5	$U_{out}-U_{Iref}$ @ $U_{Iref}=2.5\text{V}$
Electrical offset error @35°C-150°C	U_{OEHOT}	mV	-7		7	$U_{out}-U_{ref}$
Electrical offset error @-40°C-35°C	U_{OECOLD}	mV	-6.5		6.5	$U_{out}-U_{ref}$
Noise voltage spectral density	U_{n0}	$\mu\text{V}/\text{Hz}^{1/2}$		3.9		$U_{out}-GND$
Linearity error 0 ... $\pm I_{PN}$	ϵ_L	%	-0.5		0.5	Referred to I_{PN}
Linearity error 0 ... $\pm I_{PM}$	ϵ_L	%	-0.5		0.5	Referred to I_{PM} - TBC
Total error at I_{PN}	ϵ_{tot}	% of I_{PN}	-1		1	$T_A = -40^\circ\text{C} \div 150^\circ\text{C}$
Ratiometricity Error (sensitivity)	ϵ_R	%		± 0.5		$T_A = -40^\circ\text{C} \div 150^\circ\text{C}$ - TBC $U_C = 4.5 \div 5.5\text{V}$
Ratiometricity Error (offset)	ϵ_{RO}	mV	-10		10	$T_A = -40^\circ\text{C} \div 150^\circ\text{C}$

Table 23

Overcurrent detection (OCD)

Overcurrent detection is a feature included on GXL AN product to detect high peaks of currents happening during operation. Two overcurrent detection types are included in this product:

Internal OCD which offers the fastest reaction time and External OCD with a user settable threshold.

Internal overcurrent detection (OCD_INT pin)

Parameter	Symbol	Unit	Min	Typ	Max	Comment
OCD_INT detection threshold	$I_{I\text{ OCD Th}}$	A		$3 \times \pm I_{PN}$		1.5 to $5 \times \pm I_{PN}$ available. Contact LEM for more options
OCD_INT threshold error	$\varepsilon_{I\text{ OCD Th}}$	%		± 9		$U_c = 5V$
OCD_INT threshold error	$\varepsilon_{I\text{ OCD Th}}$	%		± 15		$U_c = 3.3V$
OCD_INT output on resistance to GND	$R_{on\text{ I OCD}}$	Ω		11	46	Open drain output, active low
OCD_INT output on sink capability	$I_{I\text{ OCD max}}$	mA	16	20		
OCD_INT output hold time	$t_{hold\text{ I OCD}}$	μs	8	10	12	
OCD_INT delay time	$t_{D\text{ I OCD}}$	μs			0.5	

Table 24

Overcurrent Detection Behavior

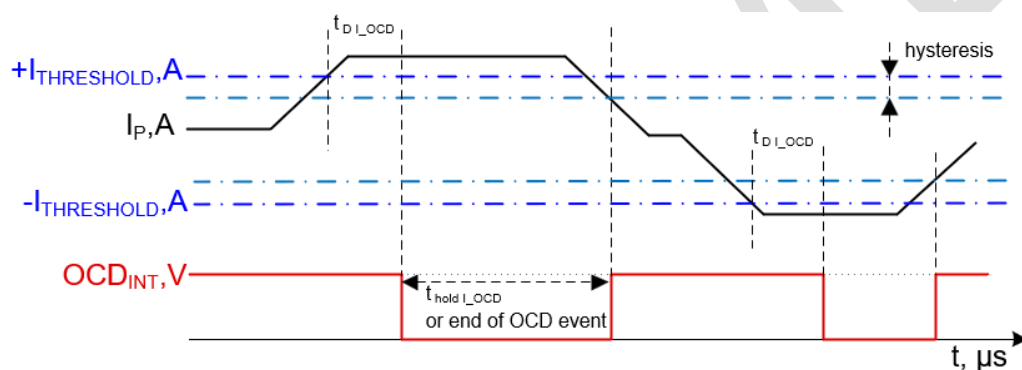


Figure 8: Internal OCD behavior

External overcurrent detection (OCD_EXT pin)

Parameter	Symbol	Unit	Min	Typ	Max	Comment
OCD_EXT threshold error ($3 \times \pm I_{PN}$)	$\varepsilon_{E\text{ OCD Th}}$	%		± 6.8		$U_c = 5V$, bipolar
OCD_EXT threshold error ($3 \times \pm I_{PN}$)	$\varepsilon_{E\text{ OCD Th}}$	%		± 11.5		$U_c = 3.3V$, bipolar
OCD_EXT output on resistance to GND	$R_{on\text{ E OCD}}$	Ω		11	46	Open drain output, active low
OCD_EXT output on sink capability	$I_{E\text{ OCD max}}$	mA	16	20		
OCD_EXT delay time	$t_{D\text{ E OCD}}$	μs		1.5	2	

Table 25

Overcurrent Detection (OCD) Threshold Selection

The input OCD threshold voltage must be very stable to ensure the selected threshold accuracy. There are different methods to provide voltage on $U_{E\text{ OCD}}$ pin: external source, resistor divider connected to reference voltage or supply voltage. The threshold current is defined based on the equation:

$$I_{\text{THRESHOLD}} = -6.5 * U_{E\text{ OCD}} + 7.8125 - \text{Eqn1. External OCD Current Threshold (5V versions)}$$

$$I_{\text{THRESHOLD}} = -10 * U_{E\text{ OCD}} + 12.5 - \text{Eqn2. External OCD Current Threshold (3.3V versions)}$$

$$U_{E_OCD} = \frac{R_E}{R_E + R_{ref}} * U_{ref} - \text{Eqn3. External OCD Voltage from reference pin (refer to figure 4)}$$

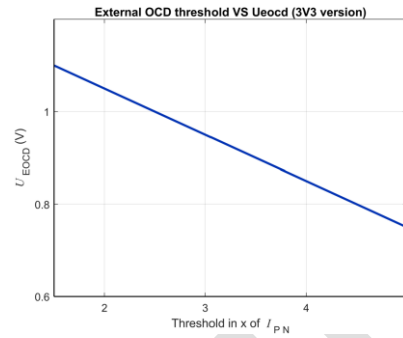
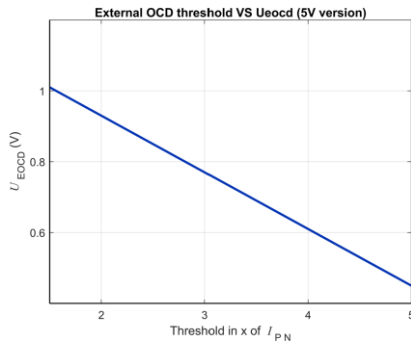


Figure 9 & 10: OCD level threshold for 5V and 3.3V versions

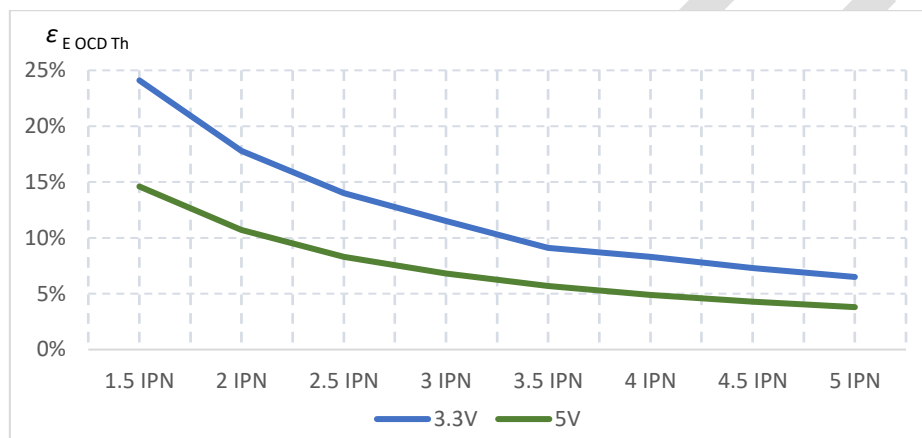


Figure 11: OCD threshold error according to the selected current for 5V and 3.3V versions

Overcurrent Detection Behavior

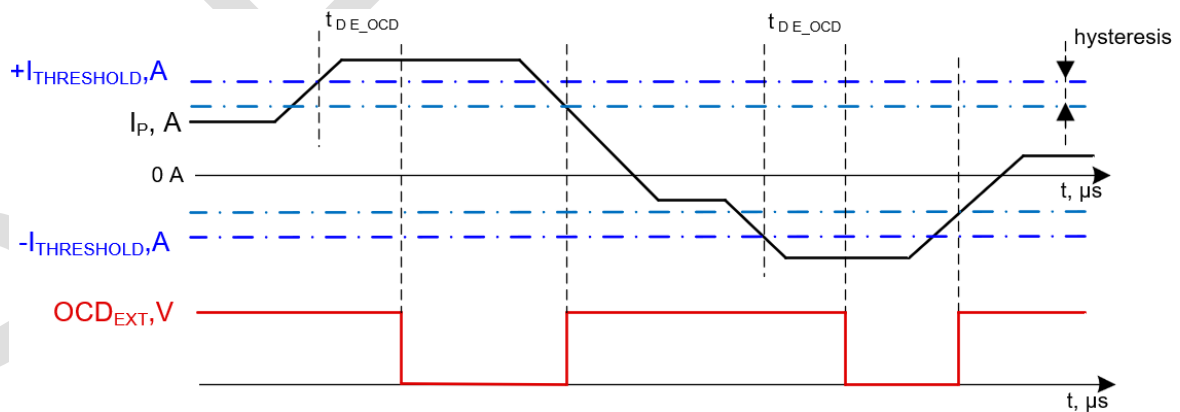


Figure 12: External OCD behavior

Electrical plots

Bandwidth

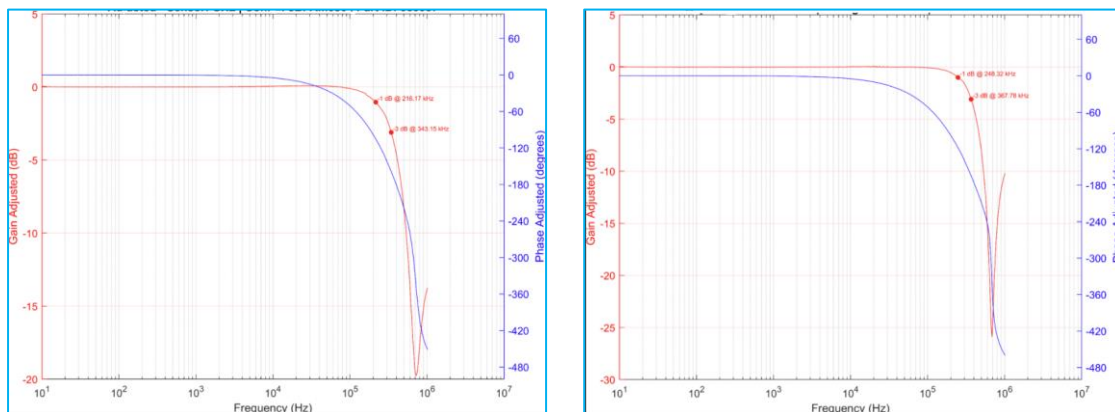


Figure 13: BW for 5V and 3.3V versions

Delay Time

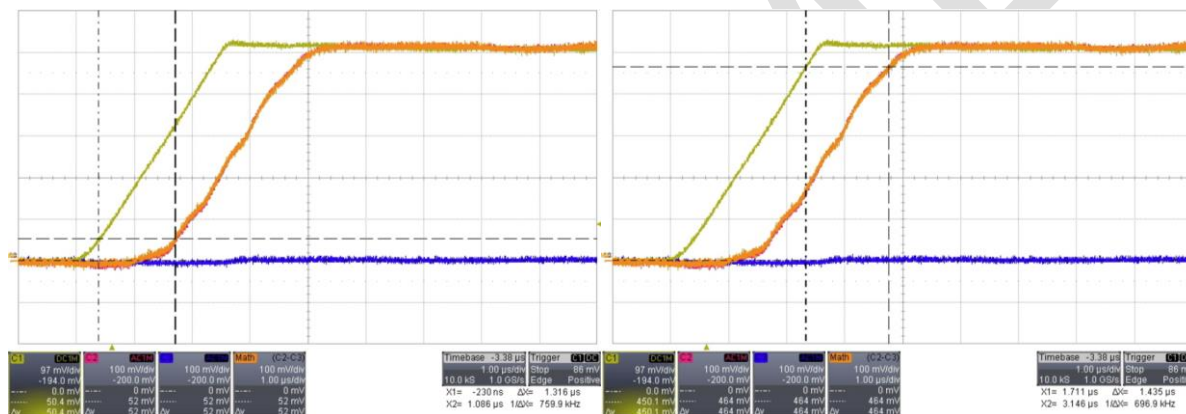


Figure 14: Delay time @10% & @90% of the signal, 3.3V version

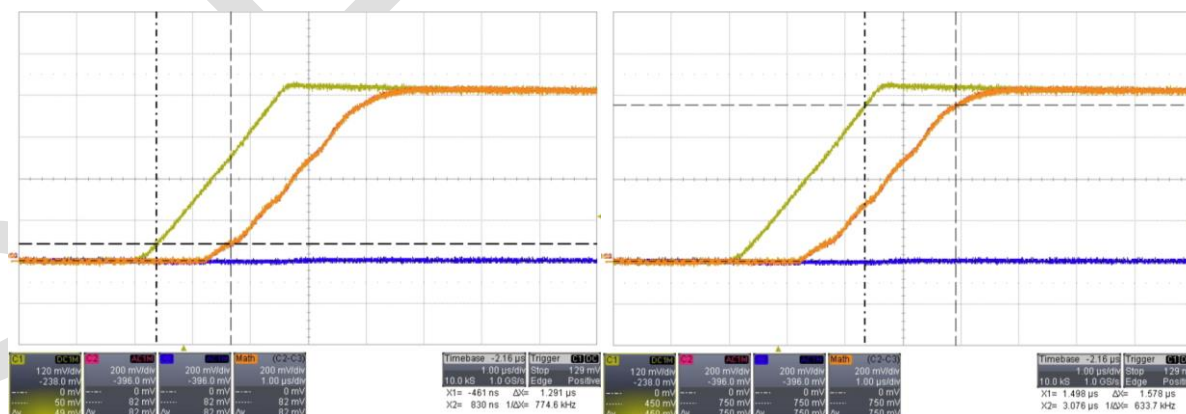


Figure 15: Delay time @10% & @90% of the signal, 5V version

Thermal characteristics

When designing a system containing a current sensor, self-heating due to the flow of the current should be considered. When a current passes through, the sensor's temperature will increase, and this may affect its performance. This change in temperature will depend on the current profile, PCB layout, cooling techniques and copper thickness. The following plots show an example of different thermal responses of the GXL AN sensor when used on an evaluation LEM board.

Figure 16 shows the continuous RMS current that GXL AN can measure depending on the maximum expected temperature of the system.

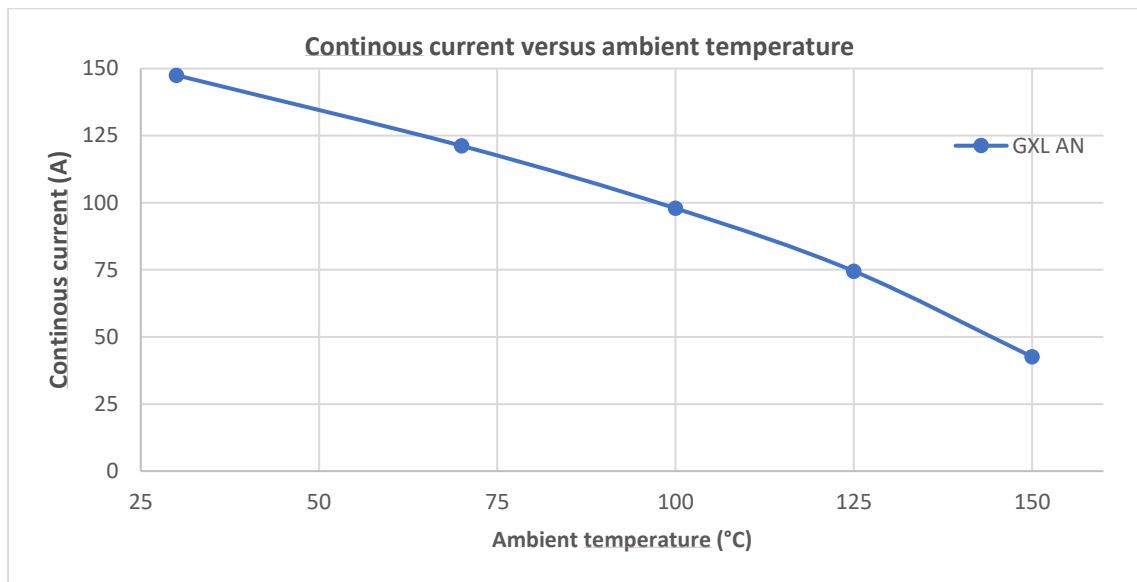


Figure 16: Measuring range vs temperature

Figure 17 represents the primary resistance variation with temperature

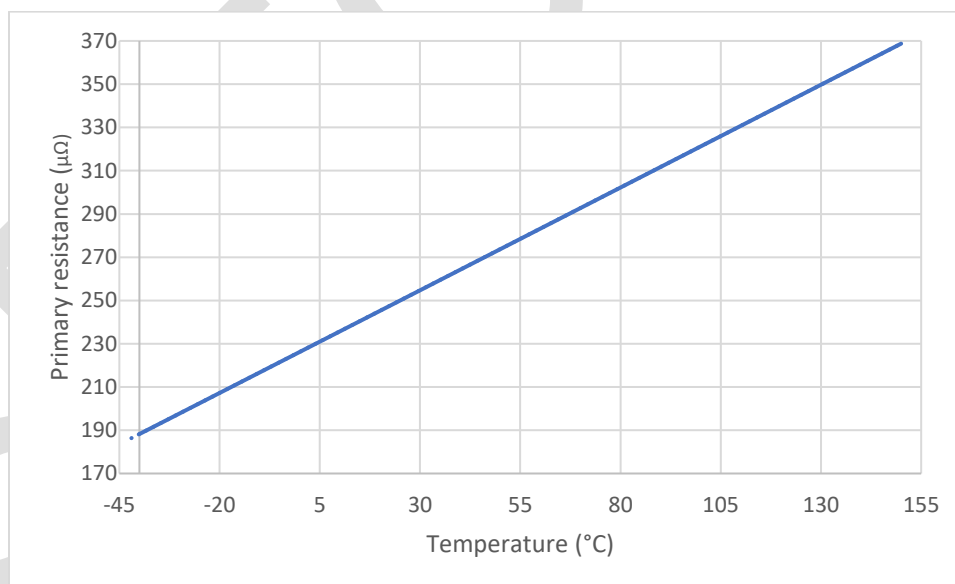


Figure 17: Primary resistance variation vs temperature

Figure 18 represents the duration of current pulse that could be applied before the primary conductor fuse. This is not representative of repeated pulse capability.

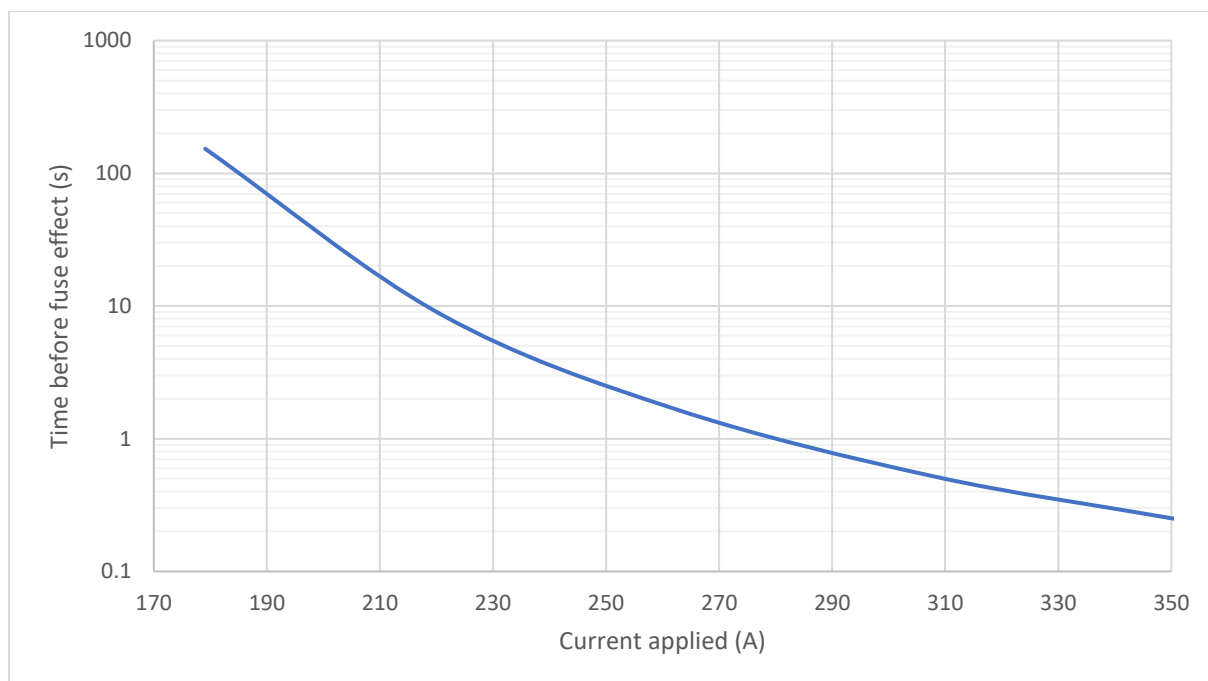


Figure 18: Fuse effect

NOTE:

The maximum temperature should be evaluated on the final system where the current sensor is integrated on the real application. This temperature should never exceed the maximum junction temperature as shown on the previous paragraphs.

Application Information

GXL-AN series supports a broad range of high-current automotive, industrial, and renewable-energy applications, including traction systems such as forklifts, golf carts, and power tools that require accurate, isolated current sensing with low loss and strong magnetic immunity. These same device characteristics also extend naturally to AC and DC power-conversion equipment, such as solar inverters, where **the device's >5 kA surge withstand capability** provides additional robustness against grid-fault and transient AC-side events. GXL-AN sensors deliver the precise AC current measurement needed for power regulation, grid synchronization, overcurrent protection, and compliance with power-quality and safety requirements.

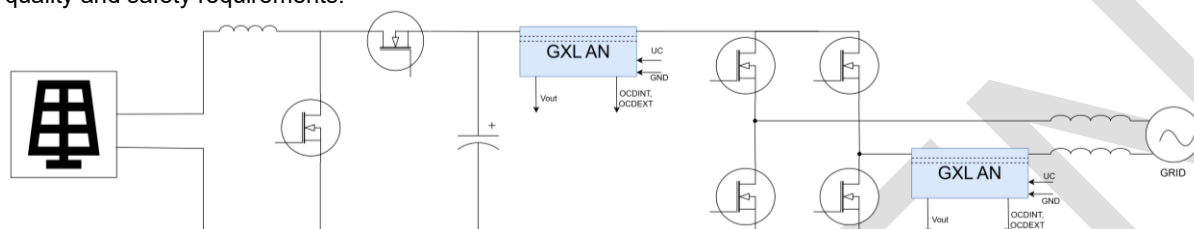


Figure 19: Typical solar application

Application feature highlights

High Power Density: Unlike traditional Hall-effect current sensors, the GXL AN uses a QFN package. To manage the thermal load of 200A, the PCB must utilize multiple layers of 2oz or 3oz copper connected through thermal vias to the primary pads (Pins 1-8). For detailed information refer to Layout section and **figure 16** showing continuous current capability of 200A I_{PN} version.

Surge Robustness: Solar installations are prone to indirect lightning strikes and grid transients. The GXL AN's 5kA surge rating ensures the sensor remains operational after a transient event, eliminating the need for oversized external shunt resistors or bulky CTs (Current Transformers).

Magnetic Immunity: In the dense electromagnetic environment of an inverter, strong stray magnetic fields generated by high-current conductors and power-stage magnetics can introduce measurement errors. The GXL's differential sensing architecture provides high rejection of external magnetic fields (CMFR), ensuring the AC waveform remains undistorted for accurate THD compliance.

Fixed mode (Non-Ratiometric mode): For applications with stable ADC reference and sensor supply, fixed mode sensors provide a better solution.

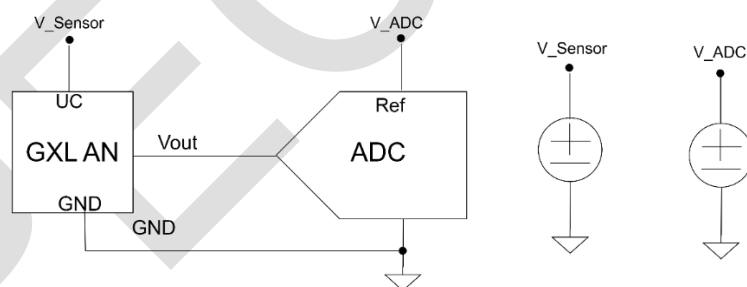


Figure 20: Simplified fixed mode interface with different supply to sensor and ADC

In applications where the sensor supply has a lower tolerance or varies considerably, the ratiometric sensors provide a better solution.

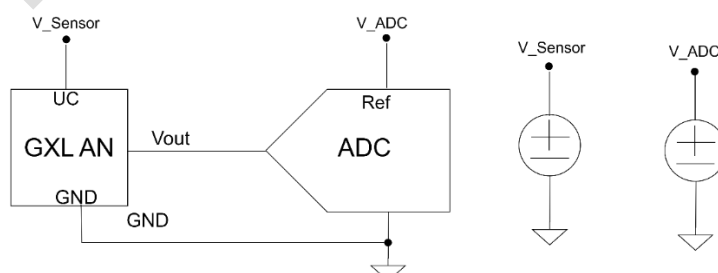


Figure 21: Simplified ratiometric mode sensor interface to ADC with same supply to ADC and sensor

Evaluation board PCB 2731

All the above results are based on a LEM evaluation board.

This evaluation board is available at our distributors or direct sales (please contact us).

Gerber files are available on LEM's website.

Description:

Evaluation board is based on 6 x 105 μm (3oz) copper layers. 6 x 500 sq.mm copper stitched on primary side.

This layout improves thermal performances of the transducer.

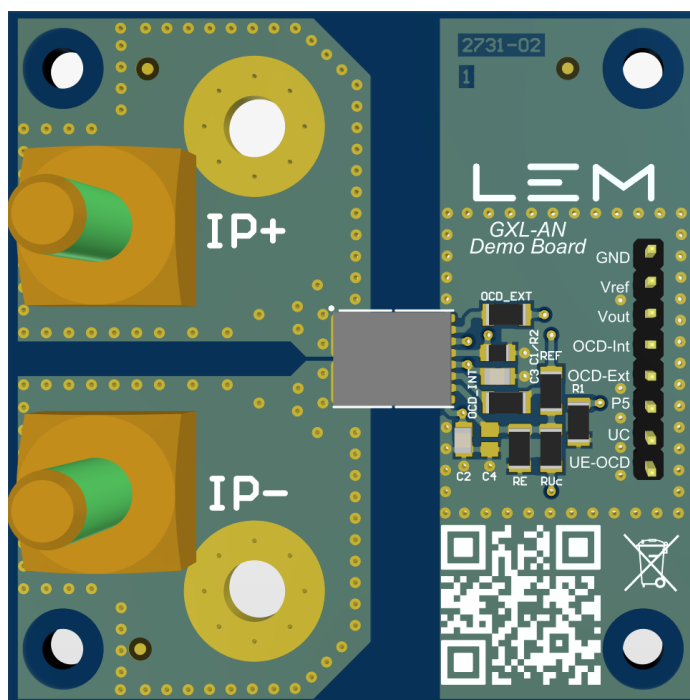


Figure 22: GXL AN demoboard

Terms and definitions

Definition of typical, minimum and maximum values

Minimum and maximum values for specified limiting and safety conditions have to be understood as such as well as values shown in “typical” graphs.

On the other hand, measured values are part of a statistical distribution that can be specified by an interval with upper and lower limits and a probability for measured values to lie within this interval.

Unless otherwise stated (e.g. “100 % tested”), the LEM definition for such intervals designated with “min” and “max” is that the probability for values of samples to lie in this interval is 99.73 %.

For a normal (Gaussian) distribution, this corresponds to an interval between -3 sigma and +3 sigma. If “typical” values are not obviously mean or average values, those values are defined to delimit intervals with a probability of 68.27 %, corresponding to an interval between -sigma and +sigma for a normal distribution.

Typical, maximal and minimal values are determined during the initial characterization of the product.

Total error referred to primary

The total error ϵ_{tot} is the error at $\pm I_{PN}$, relative to the FS (Full Scale). It includes all errors mentioned below:

- the electrical offset U_{OE}
- the sensitivity error ϵ_S
- the linearity error ϵ_L (to I_{PN})

$$\epsilon_{\text{tot}} = \frac{U_{\text{out}} + U_{\text{out TH}}}{S_N * I_{PN}} * \frac{100}{I_{PN}}, \%$$

Electrical offset

The electrical offset voltage U_{OE} is the residual output when the input current is zero (open circuit).

$$U_{OE} = \frac{U_{\text{out}(3)} + U_{\text{out}(5)}}{2}$$

It is measured using the current cycle shown in figure 35

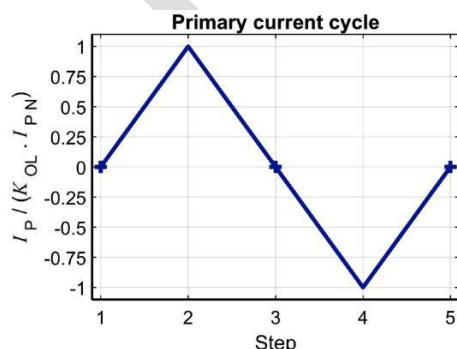


Figure 23: Current cycle used to measure offset (product supplied)

K_{OL} : Overload factor

Sensitivity and sensitivity error

To measure sensitivity, the primary current (DC) is cycled from 0 to I_{PN} , then to $-I_{PN}$ and back to 0. Sensitivity S is defined as a slope of the line connecting product output at $-I_{PN}$ with product output at $+I_{PN}$.

The sensitivity error ϵ_S is defined as the error between the measured sensitivity and the theoretical sensitivity S_{TH}

$$\epsilon_S = \frac{S - S_{TH}}{S_{TH}} * 100, \%$$

Linearity and linearity error

To measure linearity, the primary current (DC) is cycled from 0 to I_{PN} , then to $-I_{PN}$ and back to 0 (equally spaced $I_{PN}/10$ steps). The linearity error ϵ_L is the maximum positive or negative difference between the measured points and the linear regression line, expressed in % of I_{PN} .

Delay times

The delay time $t_{D 10}$ @ 10 % and the delay time $t_{D 90}$ @ 90 % with respect to the primary are shown in the next figure.

Both slightly depend on the primary current di/dt . They are measured at nominal current.

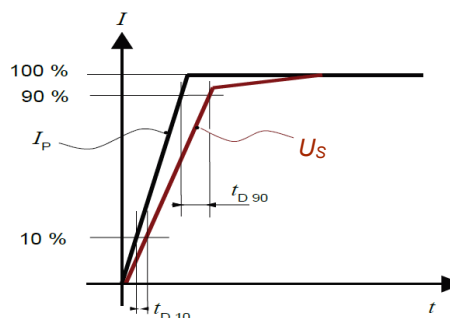


Figure 24: Delay times

PCB footprint (in mm)

GXL solder pads layout:

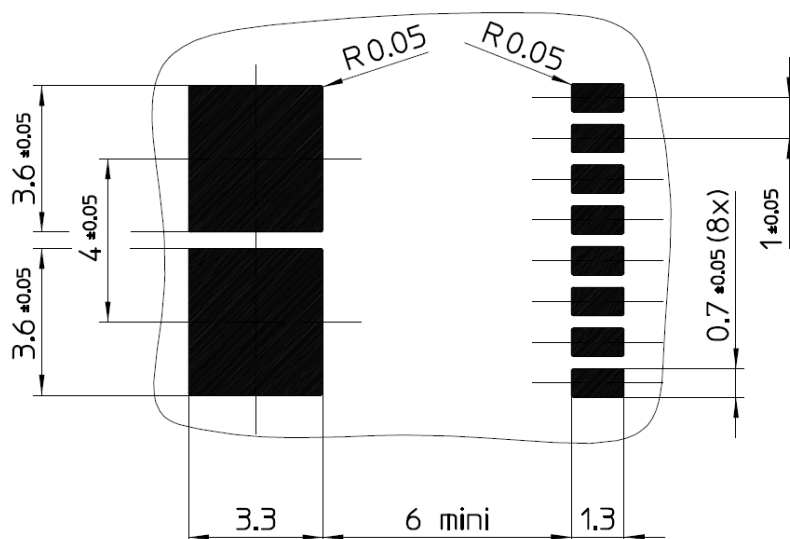


Figure 25: GXL AN PCB footprint

GXL QFN package with wettable flanks

The product leads are developed with special shape, due to soldering specifics of quad-flat no lead package (QFN). The usage of wettable flanks on QFN package provides good and stable soldering process during the assembly on PCB.

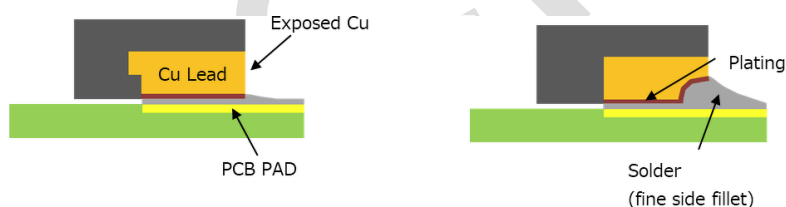


Figure 26: Standard vs wettable QFN

The package is cut on steps and plated with tin on bottom pad's side and partially sidewall. The change of exposed copper edge to the terminals with side fillet provide the ability of solder joint to extend from the pad on bottom side up to sidewall. It enhances the solder joint between the sensor and the board and is important for ensuring reliable soldering.

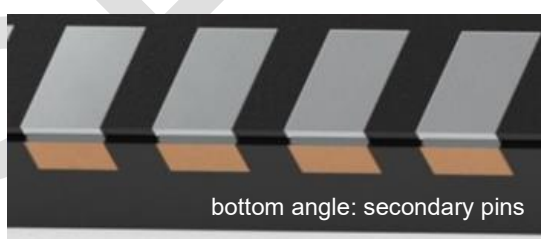


Figure 27: QFN with wettable flanks soldered on PCB

Soldering on PCB

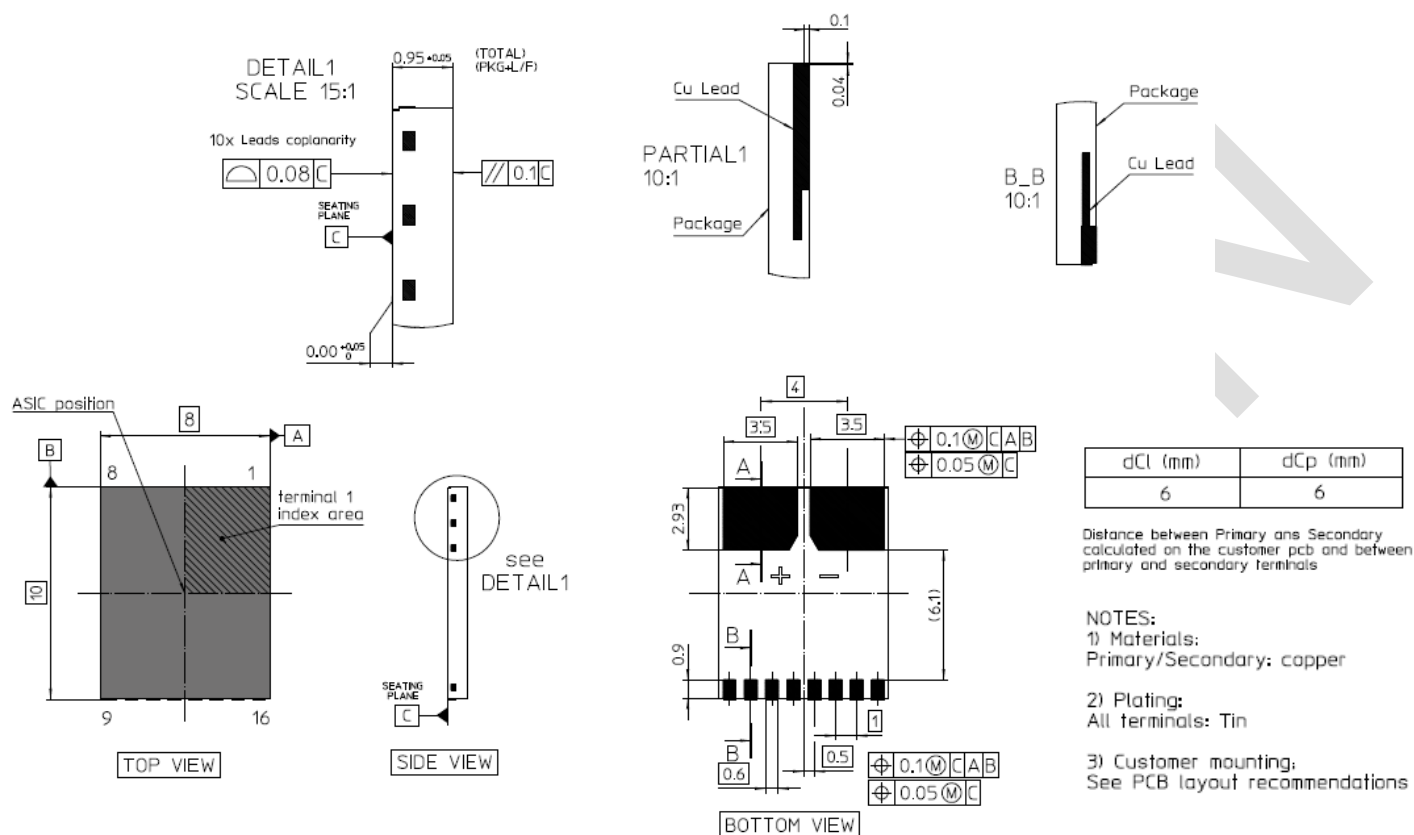
Soldering remarks:

- GXL is targeted to be qualified MSL3 for storage and mounting purposes.
- Per JEDEC J-STD-020E for packages less than 1.6 mm thick per table 4.2 (Pb-Free Process) of the specification.
- Best practice is to use 7 zones or greater conventional reflow system, limiting the time at reflow temperature as indicated in profile above.
- Rework not recommended.

SPECIMEN

Dimensions (in mm)

GXL drawings:

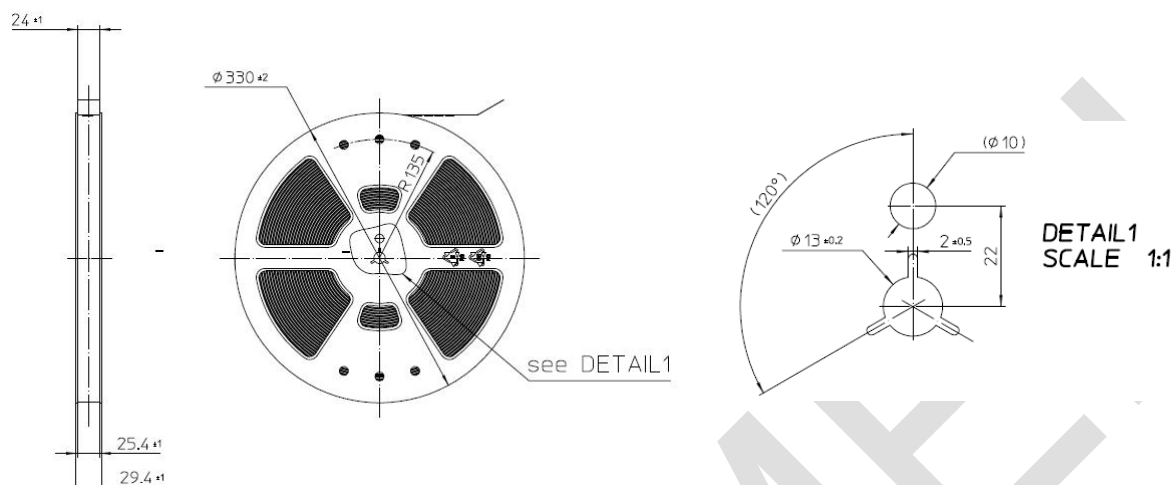


Mechanical characteristics: General tolerance $\pm 0.15\text{ mm}$

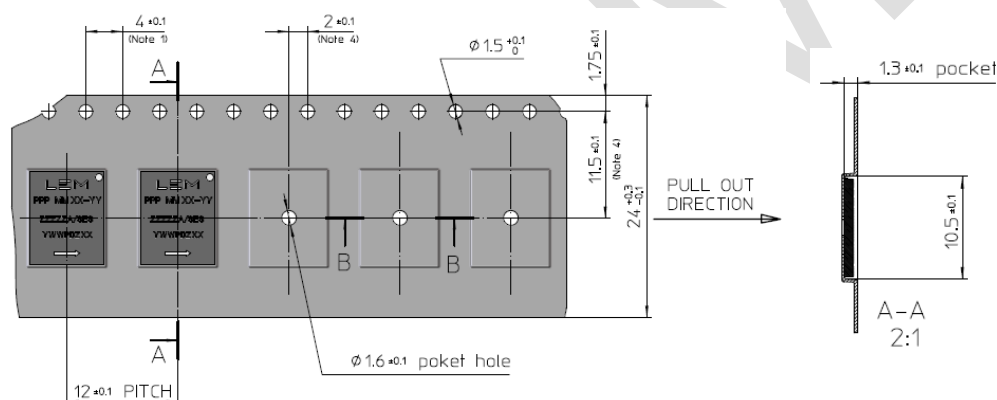
Remark: $U_{\text{out}} - U_{\text{ref}}$ is positive when I_P flows in the direction of arrow (pin 1 to pin 8).

Tape and Reel (in mm)

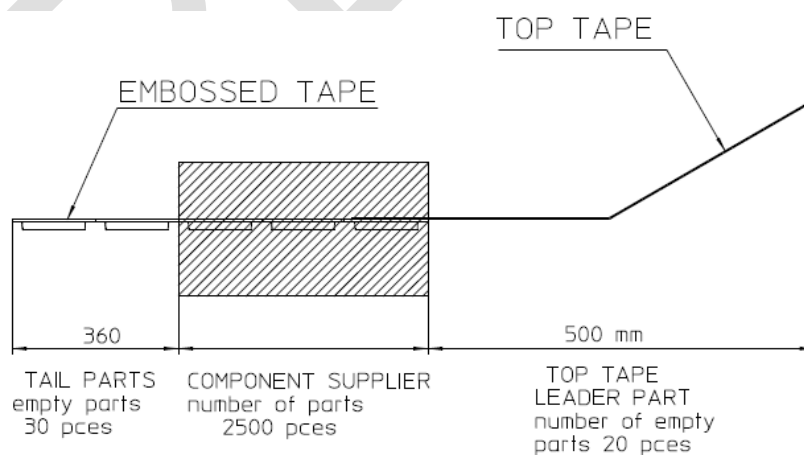
Plastic Reel Data:



Carrier Tape Data:



Leader and Trailer:



Safety



Caution

This transducer must be used in electric/electronic equipment with respect to applicable standards and safety requirements in accordance with the manufacturer's operating instructions.

Caution, risk of electrical shock



This transducer must be used in limited-energy secondary circuits according to IEC 62368-1.

When operating the transducer, certain parts of the module can carry hazardous voltages and high currents (e.g. power supply, primary conductor). Ignoring this warning can lead to injury and or/cause serious damage.

This transducer is a build-in device, whose hazardous live parts must be inaccessible after installation. A protective enclosure or additional shield could be used. Main supply must be able to be disconnected.

Although LEM applies utmost care to facilitate compliance of end products with applicable regulations during LEM product design, use of this part may need additional measures on the application side for compliance with regulations regarding EMC and protection against electric shock. Therefore, LEM cannot be held liable for any potential hazards, damages, injuries or loss of life resulting from the use of this product.

ESD susceptibility



This product is susceptible to be damaged from an ESD event and the personnel and workspace should be grounded when handling it.



Underwriters Laboratory Inc. recognized component

Revision history

Version	Date	Description
0.1	15 th of February 2024	Initial Release – target datasheet
0.4	27 th of September 2024	8 products listed, performance update based on measurements, minor cosmetics improvements.
0.5	8 th of January 2025	Correction on Total Error referred to IPM (previous version referring to Ipn)
0.6	6 th of March 2025	New legal page added at the end of the document. UL added on safety page.
0.7	19 th of May 2026	New Thermal characteristics, Electrical plots, Application Information, Tape and reel, Updated Parameters table, Application schematic, Block diagram, Terms and definitions

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